

**IN THE CLAIMS**

This listing of claims will replace all prior versions, and listings, of claims in the application:

1. (Previously Presented) An apparatus, comprising:

a printed circuit board having a first surface of the material of the printed circuit board, itself, and a mounting hole formed through the first surface and the material of the printed circuit board;

a solder ring disposed upon the first surface of the material of the printed circuit board, itself, and surrounding the mounting hole formed through the first surface and material of the printed circuit board, itself; and

a ferrule having a body with a channel formed therethrough from a first end of the body having a capture extension, to a second end of the body having a soldering extension in the form of a solder flange providing a soldering surface to solder the ferrule to the solder ring at a location overlying the solder ring where the channel formed through the ferrule and the mounting hole formed through the first surface and material of the printed circuit board, itself, align.

2. (Original) The apparatus of claim 1, wherein the ferrule is substantially cylindrical in shape.

3. (Canceled)

4. (Original) The apparatus of claim 1, wherein the capture extension is used to hold a screw protruding through the channel formed through the ferrule captive to the ferrule.

5. (Original) The apparatus of claim 4, wherein the capture extension is a capture flange surrounding the channel formed through the ferrule at the first end.

Approved to Enter  
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